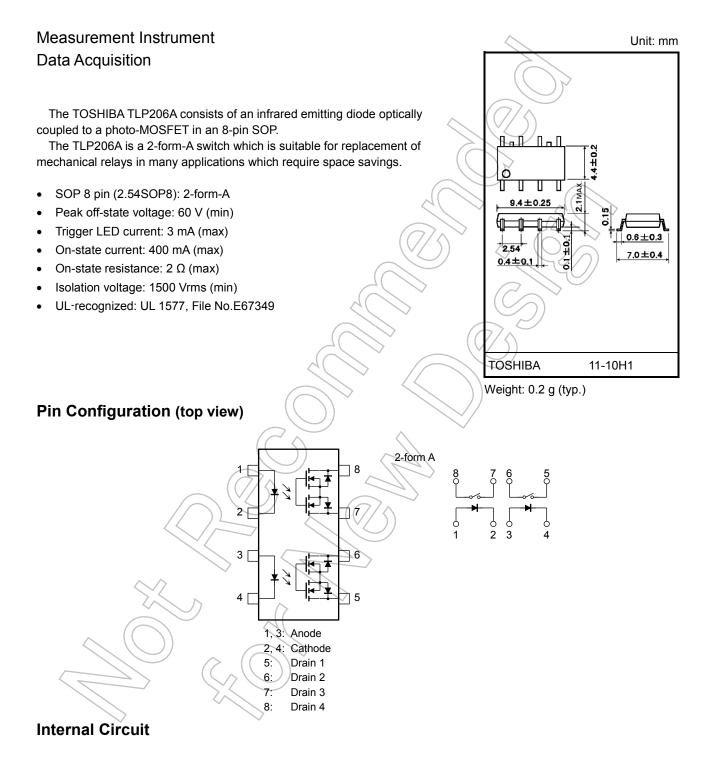
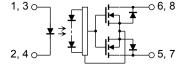
TOSHIBA Photocoupler IRED & Photo-MOSFET

TLP206A





Start of commercial production 1997-10

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
	Forward current	IF	50	mA	
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C	^
	Pulse forward current (100 µs pulse, 100 pps)	IFP	1	А	
LED	Reverse voltage	V _R	5	V	\
	Diode power dissipation	PD	50	mW (7/
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-0.5	mW/°C	
	Junction temperature	Tj	125	(°C	7
	Off-state output terminal voltage	V _{OFF}	60	V	
	On-state current	Ion	400	mA	
	On-state RMS current derating (Ta ≥ 25°C)	Δl _{ON} /°C	-4,0	mA/°C	_
Detector	Output power dissipation	Po	180	mW	
	Output power dissipation derating (Ta ≥ 25°C)	ΔPo/°C	-1.8	mW / °C	0
	Junction temperature	Tj	125	°C	
Storage temperature range		Tstg	-55 to 125	°¢()	20
Operating temperature range		Topr	-40 to 85	·c/	7)
Lead soldering temperature (10 s)		Tsol	260	°C	
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BVs	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	48	V
Forward current	lF	5	7.5	25	mA
On-state current	I _{ON}	_	_	400	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V _R = 5 V	_	_	10	μΑ
	Capacitance	Ст	V _F = 0 V, f = 1 MHz	<u> </u>	30	_	pF
Detector	Off-state current	loff	V _{OFF} = 60 V		_	1	μΑ
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz		130	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	lfT	ION = 400 mA	_	1	3	mA
On-state resistance	Ron	ION = 400 mA, I _F = 5 mA	- ^	77	2	Ω

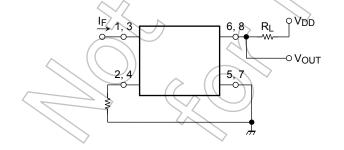
Isolation Characteristics (Ta = 25°C)

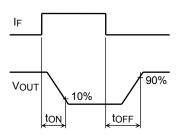
Characteristics	Symbol	Test Condition	Min	> Typ.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz		0.8	-	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	-	Ω
Isolation voltage	BVs	AC, 60 s	1500	1		Vrms

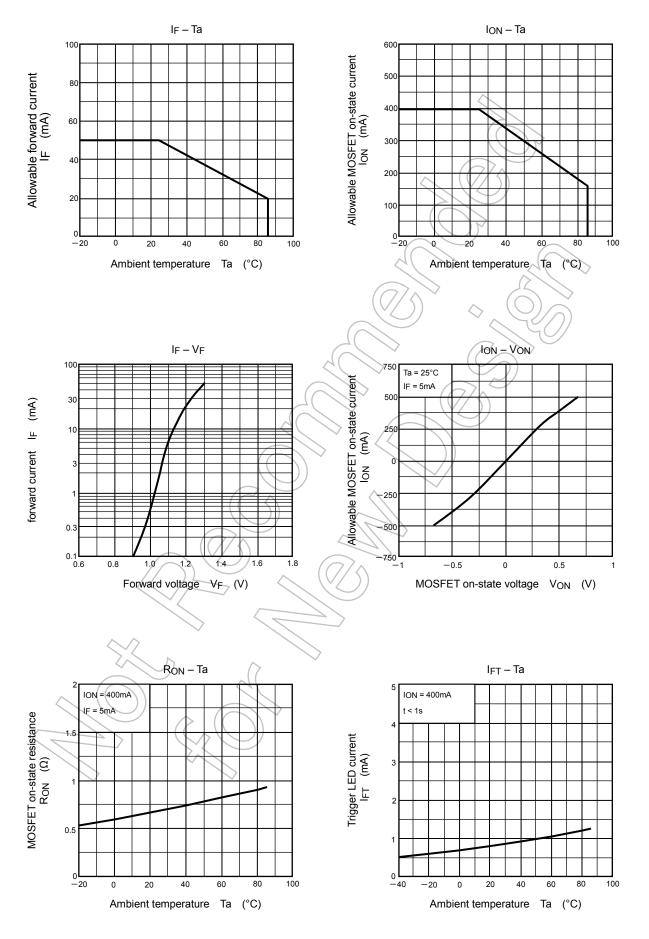
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	R _L = 200 Ω V _{DD} = 20 V, I _F = 5 mA	(Note 2)		0.6	2.0	ms
Turn-off time	toff	$R_L = 200 \Omega$ $V_{DD} = 20 \text{ V, I}_F = 5 \text{ mA}$	(Note 2)		0.1	1.0	ms

Note 2: Switching time test circuit







NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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